



Mr. Robert J. Vermillion, CPP, Fellow

Date 05 March 2019

RMV Technology Group, LLC

Dear Mr. Vermillion,

On behalf of NIPHLE, it is with great pleasure that I announce your selection as an inductee into the Military Packaging Hall of Fame. You can be proud of your accomplishments in the military packaging career field. This Honor, bestowed upon you by your peers and fellow packaging professionals, is in direct recognition of your stature in the military packaging community.

Induction into the Military Packaging Hall of Fame will take place during the banquet at the National Institute of Packaging, Handling and Logistics Engineers (NIPHLE) Training on 22 May 2019 at the Embassy Suites in Huntsville, AL. Please respond to this letter via email with the number of family members who will attend. If you are unable to attend, please designate a representative to receive the Award on your behalf. If a representative is not available, we will select a representative for you. Additional information about the 2019 Training and Hotel is located on the NIPHLE WEBSITE <https://www.niphle.org/>.

Please provide a digital photo of yourself in a .jpg format (12" w x 9" h at 96 dpi in landscape orientation) as soon as possible, which we may use in our Military Packaging Hall of Fame display on the website. Email your picture to mwerneke@earthlink.net.

Please contact me upon receipt of this letter to arrange acceptance of your award. My contact information is Jennifer.smith2@dla.mil or 717-770-4492. Once again, Congratulations!

Sincerely,

Jennifer D. Smith

Jennifer D. Smith

Chair, NIPHLE Military Packaging Hall of Fame